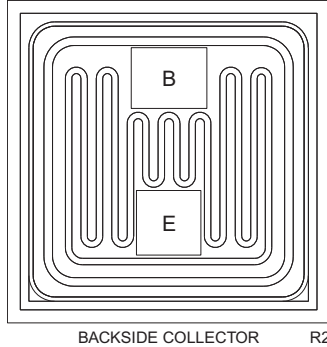


# CP310-CMPTA44

## NPN - High Voltage Transistor Die

The CP310-CMPTA44 is a silicon NPN transistor designed for extremely high voltage applications.



### MECHANICAL SPECIFICATIONS:

|                          |                |
|--------------------------|----------------|
| Die Size                 | 26 x 26 MILS   |
| Die Thickness            | 9.0 MILS       |
| Base Bonding Pad Size    | 6.1 x 4.9 MILS |
| Emitter Bonding Pad Size | 5.2 x 5.2 MILS |
| Top Side Metalization    | Al – 30,000Å   |
| Back Side Metalization   | Au – 9,000Å    |
| Scribe Alley Width       | 2.2 MILS       |
| Wafer Diameter           | 5 INCHES       |
| Gross Die Per Wafer      | 25,214         |

### MAXIMUM RATINGS: ( $T_A=25^\circ\text{C}$ )

|                                            | SYMBOL         |             | UNITS            |
|--------------------------------------------|----------------|-------------|------------------|
| Collector-Base Voltage                     | $V_{CBO}$      | 450         | V                |
| Collector-Emitter Voltage                  | $V_{CEO}$      | 400         | V                |
| Emitter-Base Voltage                       | $V_{EBO}$      | 6.0         | V                |
| Continuous Collector Current               | $I_C$          | 300         | mA               |
| Operating and Storage Junction Temperature | $T_J, T_{stg}$ | -65 to +150 | $^\circ\text{C}$ |

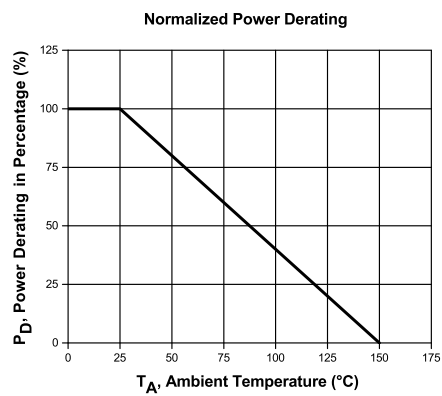
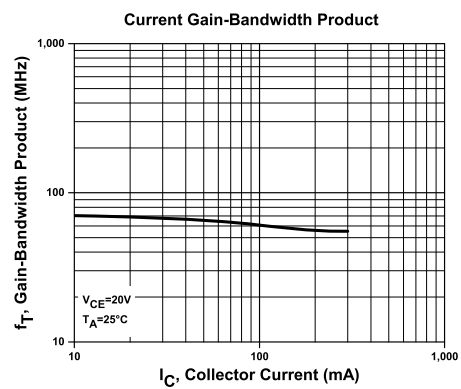
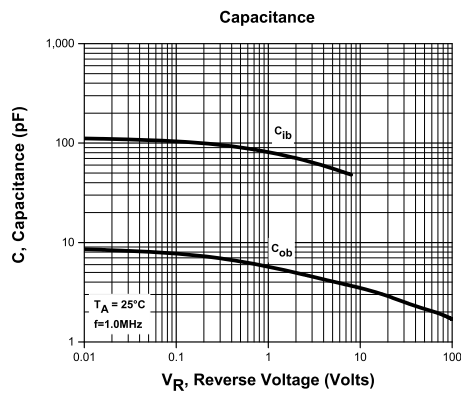
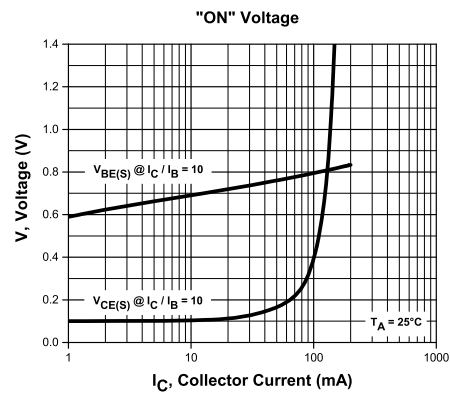
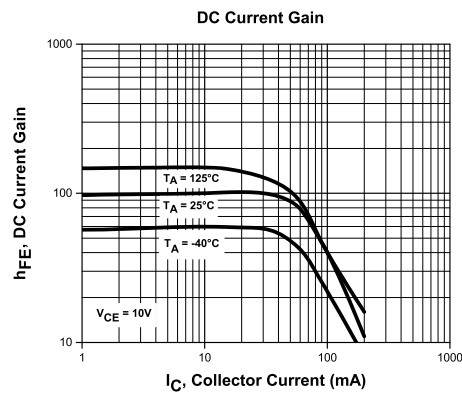
### ELECTRICAL CHARACTERISTICS: ( $T_A=25^\circ\text{C}$ )

| SYMBOL        | TEST CONDITIONS                                      | MIN | MAX  | UNITS |
|---------------|------------------------------------------------------|-----|------|-------|
| $I_{CBO}$     | $V_{CB}=400\text{V}$                                 |     | 100  | nA    |
| $I_{CES}$     | $V_{CE}=400\text{V}$                                 |     | 500  | nA    |
| $I_{EBO}$     | $V_{BE}=4.0\text{V}$                                 |     | 100  | nA    |
| $BV_{CBO}$    | $I_C=100\mu\text{A}$                                 | 450 |      | V     |
| $BV_{CES}$    | $I_C=100\mu\text{A}$                                 | 450 |      | V     |
| $BV_{CEO}$    | $I_C=1.0\text{mA}$                                   | 400 |      | V     |
| $BV_{EBO}$    | $I_E=10\mu\text{A}$                                  | 6.0 |      | V     |
| $V_{CE(SAT)}$ | $I_C=1.0\text{mA}, I_B=0.1\text{mA}$                 |     | 0.40 | V     |
| $V_{CE(SAT)}$ | $I_C=10\text{mA}, I_B=1.0\text{mA}$                  |     | 0.50 | V     |
| $V_{CE(SAT)}$ | $I_C=50\text{mA}, I_B=5.0\text{mA}$                  |     | 0.75 | V     |
| $V_{BE(SAT)}$ | $I_C=10\text{mA}, I_B=1.0\text{mA}$                  |     | 0.75 | V     |
| $h_{FE}$      | $V_{CE}=10\text{V}, I_C=1.0\text{mA}$                | 40  |      |       |
| $h_{FE}$      | $V_{CE}=10\text{V}, I_C=10\text{mA}$                 | 50  | 200  |       |
| $h_{FE}$      | $V_{CE}=10\text{V}, I_C=50\text{mA}$                 | 45  |      |       |
| $h_{FE}$      | $V_{CE}=10\text{V}, I_C=100\text{mA}$                | 20  |      |       |
| $f_T$         | $V_{CE}=10\text{V}, I_C=10\text{mA}, f=10\text{MHz}$ | 20  |      | MHz   |
| $C_{ob}$      | $V_{CB}=20\text{V}, I_E=0, f=1.0\text{MHz}$          |     | 7.0  | pF    |
| $C_{ib}$      | $V_{EB}=0.5\text{V}, I_C=0, f=1.0\text{MHz}$         |     | 130  | pF    |

R0 (9-May 2016)

# CP310-CMPTA44

## Typical Electrical Characteristics



## BARE DIE PACKING OPTIONS

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### BARE DIE IN TRAY (WAFFLE) PACK

**CT:** Singulated die in tray (waffle) pack.  
(example: CP211-PART NUMBER-CT)

**CM:** Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes).  
(example: CP211-PART NUMBER-CM)

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### UNSAWN WAFER

**WN:** Full wafer, unsawn, 100% tested with reject die inked.  
(example: CP211-PART NUMBER-WN)

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### SAWN WAFER ON PLASTIC RING

**WR:** Full wafer, sawn and mounted on plastic ring,  
100% tested with reject die inked.  
(example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications:  
**[www.centrasemi.com/bdspecs](http://www.centrasemi.com/bdspecs)**

## OUTSTANDING SUPPORT AND SUPERIOR SERVICES



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### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

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### DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

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### REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

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### CONTACT US

#### Corporate Headquarters & Customer Support Team

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**Worldwide Distributors:**  
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